

30A, 1200V SiC Merged PIN Schottky Diode

FEATURES

- AEC-Q101 qualified
- Max junction temperature 175°C
- High-speed switching possible
- High forward surge capability
- High-frequency operation
- Positive temperature coefficient on V_F
- RoHS compliant
- Halogen-free

ΔPI			

- General purpose
- Switch mode power supplies
- Power factor correction

MECHANICAL DATA

• Case: TO-247-3L

Molding compound meets UL 94V-0 flammability rating

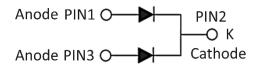
• Terminal: Matte tin plated leads, solderable per J-STD-002

Polarity: As circuit diagramWeight: 6.27g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
l _F	30	Α		
V_{RRM}	1200	V		
IFSM	148	Α		
T _{J MAX}	175	°C		
Package	TO-247-3L			
Configuration	Common cathode			







ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	VALUE	UNIT	
Repetitive peak reverse voltage		V_{RRM}	1200	V	
Reverse voltage, total rms value		V _{R(RMS)}	840	V	
Forward current per device		lF	30	Α	
Surge peak forward current 10ms single half	T _C = 25°C	IFSM	148	Α	
sine-wave superimposed on rated load per leg	T _C = 150°C		131	Α	
Non-repetitive peak forward surge current	t _p = 10µs	I _{F, MAX}	1158	Α	
Junction temperature		TJ	-55 to +175	°C	
Storage temperature		Tstg	-55 to +175	°C	



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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	MAX	UNIT	
Junction-to-case thermal resistance per leg	Rejc	0.74	0.89	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per leg ⁽¹⁾	I _F = 7.5A, T _J = 25°C	VF	1.16	-	V
	I _F = 15A, T _J = 25°C		1.38	1.50	V
	I _F = 7.5A, T _J = 150°C		1.30	-	V
	I _F = 15A, T _J = 150°C		1.81	2.10	V
	I _F = 7.5A, T _J = 175°C		1.35	-	V
	I _F = 15A, T _J = 175°C		1.95	-	V
Reverse current @ rated V _R per leg ⁽²⁾	T _J = 25°C		-	30	μA
	T _J = 175°C	- I _R	-	100	μA
Junction capacitance per leg	f = 1MHz, V _R = 1V	0	1112	-	pF
	f = 1MHz, V _R = 800V	- C _J	56	-	pF
Capacitive Charge per leg	V _R = 800V	Qc	74	-	nC

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE	PACKAGE	PACKING			
TSCDH30120G2H	TO-247-3L	30 / Tube			



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Typical Forward Characteristics

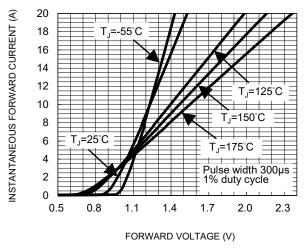


Fig.3 Peak forward current versus case temperature

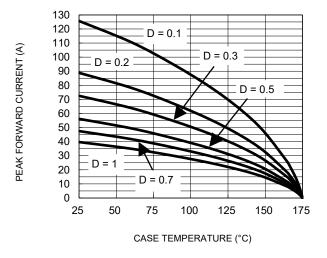


Fig.5 Typical Capacitive Charge

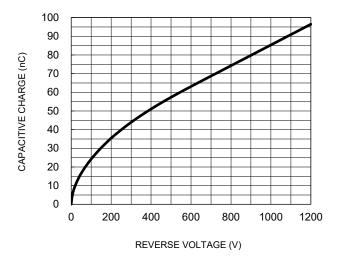


Fig.2 Typical Reverse Characteristics

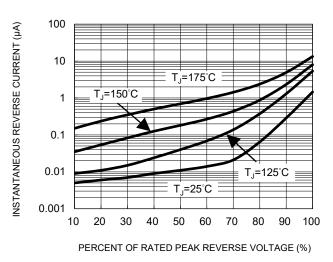


Fig.4 Typical Junction Capacitance

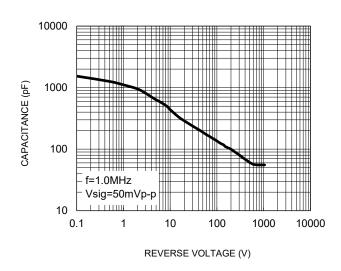
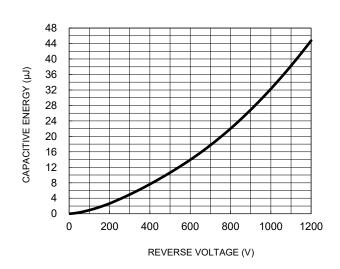


FIG.6 Typical Capacitance Stored Energy

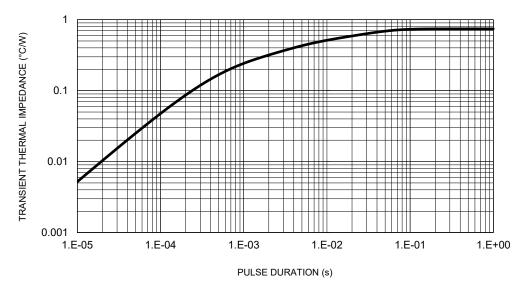


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CHARACTERISTICS CURVES

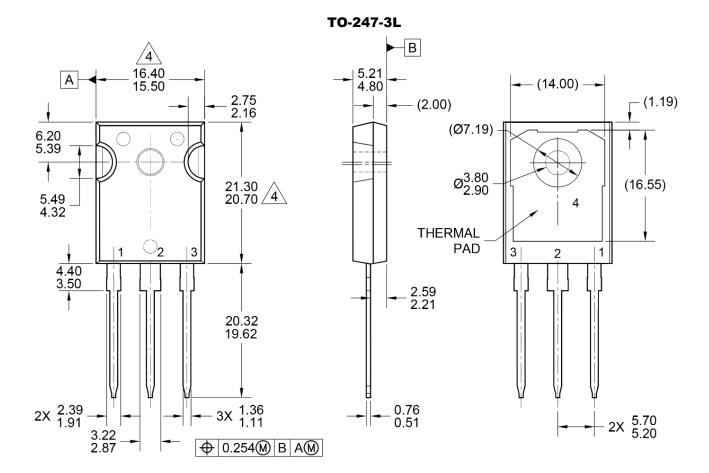
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

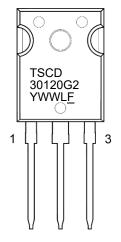
Fig.7 Typical Transient Thermal Characteristics





PACKAGE OUTLINE DIMENSIONS





MARKING DIAGRAM

Y = Year Code

WW = Week Code (01~52) L = Lot Code (1~9,A~Z) F = Factory Code NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-247, VARIATION AD, ISSUE E.

DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.

5. DWG NO. REF: HQ2SD07-TO247ADSiC-122 REV A.



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